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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/671,436	09/27/2000	Yoshinari Matsuda	09792909-0425	6069
7590	12/13/2005			EXAMINER LEVI, DAMEON E
David R Metzger Sonnenschein Nath & Rosenthal P O Box 061080 Wacker Drive Station Sears Tower Chicago, IL 60606-1080			ART UNIT 2841	PAPER NUMBER
DATE MAILED: 12/13/2005				

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No.	Applicant(s)
	09/671,436	MATSUDA ET AL.
	Examiner	Art Unit
	Dameon E. Levi	2841

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

1) Responsive to communication(s) filed on 24 October 2005.
 2a) This action is FINAL. 2b) This action is non-final.
 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

4) Claim(s) 1-6 and 8-20 is/are pending in the application.
 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
 5) Claim(s) _____ is/are allowed.
 6) Claim(s) 1-6 and 8-20 is/are rejected.
 7) Claim(s) _____ is/are objected to.
 8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

9) The specification is objected to by the Examiner.
 10) The drawing(s) filed on 27 September 2000 is/are: a) accepted or b) objected to by the Examiner.
 Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
 Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
 a) All b) Some * c) None of:
 1. Certified copies of the priority documents have been received.
 2. Certified copies of the priority documents have been received in Application No. _____.
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

1) Notice of References Cited (PTO-892)
 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)
 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
 Paper No(s)/Mail Date _____.
 4) Interview Summary (PTO-413)
 Paper No(s)/Mail Date _____.
 5) Notice of Informal Patent Application (PTO-152)
 6) Other: _____.

DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 1-6, and 8 are rejected under 35 U.S.C. 103(a) as being as being unpatentable over Fushie et al US Patent 6339197 in view of Jones et al US Patent 6069443.

Regarding claim 1, Fushie et al discloses a printed circuit board comprising: a glass substrate(element 2, Figs 1-6C, 20, Figs 7A-8B, 32, Figs 9A-12B) provided with through-holes(elements 3, Figs 1-6C) , conductive patterns(elements 6, Figs 1-6C) provided on both surfaces of the glass substrate in such a manner as to be made conductive to each other via the through-holes, and a sealing member(element 8, Figs 1-6C) provided to fill the through holes, the sealing member being operable to inhibit moisture permeation through the through holes .

Fushie et al does not expressly disclose the glass substrate having a sealed side surface facing the portion to be sealed from moisture and an exposed side surface; or, the conductive patterns on said sealed side surface being connected to at least one display element.

Jones et al discloses a device comprising a glass substrate having a sealed side surface (elements 2, 30, Figs 3-6) facing a portion to be sealed from moisture and an exposed side surface(bottom side surface of elements 2, Figs 3-6); and, the conductive patterns on said sealed side surface being connected to at least one display element(elements 2,40,19 Figs 3-6).

Accordingly, it would have been obvious to one of ordinary skill in the art, at the time the invention was made to have included a sealed side surface and an exposed side surface, as well as, to connect the conductive patterns to a display element as taught by Jones et al using the substrate as taught by Fushie et al for the purpose of providing a low pinhole density moisture barrier, as well as, to electrically connect the display element to the substrate (see Jones et al column 8, lines 1-65)

Regarding claim 2, Fushie et al discloses wherein the glass substrate is a no-alkali glass substrate (Fig 7A).

Regarding claim 3, Fushie et al discloses wherein the sealing member is a conductive Paste containing an epoxy resin as a binder (element 8, Figs 1-6C)

Regarding claim 4, Fushie et al discloses wherein a conductive film is provided on an inner wall surface of each of the through-holes in such a manner as to connect the conductive patterns provided on both surfaces of the glass substrate to each other, and an inner space, inside the conductive film, of the through-hole is filled with the sealing member (elements 3,8 Figs 1-6C)

Regarding claim 5, Fushie et al discloses wherein the sealing member is an epoxy resin(elements 8, Figs 1-6C)

Regarding claim 6, Fushie et al discloses wherein the surface of the sealing member exposed from each of the through-holes is covered with a metal film (elements 3,8 Figs 1-6C)

Regarding claim 8, Fushie et al discloses wherein each of said conductive patterns has a stacked structure of an epoxy resin film and a copper film formed thereon(element 35a, 35b, 35c, Figs 1-14).

Claims 9-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Fushie et al US Patent 6339197 in view of Jones et al US Patent 6069443, Stevens US Patent 6392356 and further in view of Nakazawa et al US Patent 6411349

Regarding claim 9, Fushie et al discloses a device comprising:
a printed wiring board including a glass substrate(element 2, Figs 1-6C, 20, Figs 7A-8B, 32, Figs 9A-12B) provided with through-holes(elements 3, Figs 1-6C),
conductive patterns(elements 6, Figs 1-6C) provided on both surfaces of the glass substrate in such a manner as to be made conductive to each other via the through holes, and a first sealing member(element 8, Figs 1-6C) provided to fill the through-holes;

Jones et al discloses a device comprising a glass substrate having a sealed side surface (elements 2, 30, Figs 3-6) facing a portion to be sealed from moisture and an exposed side surface(bottom side surface of elements 2, Figs 3-6); and, the conductive patterns on said sealed side surface being connected to at least one display element(elements 2,40,19 Figs 3-6).

Stevens et al discloses a display device assembly comprising

• a display device provided on one surface of the printed wiring board in such a manner as to be connected to a conductive pattern provided on a one surface of a printed wiring board(elements 30, Fig 3)

• a drive component for driving the display device, the drive component being disposed on the exposed surface of the printed wiring board in such a manner as to be connected to the conductive pattern provided on the other surface of the printed wiring board(elements 70,72, Figs 1-3, see column 5, lines 5-25)

Nakazawa et al discloses a display device assembly wherein

• a second sealing member provided in such a manner as to surround a display device while being in contact with a printed wiring board and a protective glass board (element 252, Fig 12)

Accordingly, it would have been obvious to one of ordinary skill in the art at the time the invention was made to have included the glass circuit board with a sealed side surface and an exposed side surface and to connect the conductive patterns to a display element as taught by Fushie et al and Jones et al for the purpose of providing a low pinhole density moisture barrier, as well as, to electrically connect the display element to the substrate(see Jones et al column 8, lines 1-65) and also to arrange the display device components as taught by Stevens for the purpose of achieving a denser array of driver components in order to increase pixel pitch in the display device and additionally to add the second sealing member as taught by Nakazawa et al for the purpose vacuum sealing the assembly as a whole.

Regarding claim 10, Fushie et al disclose the instant wherein the glass substrate is a no-alkali glass substrate(Fig 7A)

Regarding claim 11, Fushie et al discloses wherein the sealing member is a conductive

paste containing an epoxy resin as a binder (element 8, Figs 1-6C)

Regarding claim 12, Fushie et al discloses wherein a conductive film is provided on an inner wall surface of each of the through-holes in such a manner as to connect the conductive patterns provided on both surfaces of the glass substrate to each other, and an inner space, inside the conductive film, of the through-hole is filled with the sealing member (elements 3,8 Figs 1-6C)

Regarding claim 13, Fushie et al discloses wherein the second sealing member is an epoxy resin(elements 8, Figs 1-6C)

Regarding claim 14, Fushie et al discloses wherein the surface of the sealing member exposed from each of the through-holes is covered with a metal film (elements 3,8 Figs 1-6C)

Regarding claim 15, Fushie et al discloses a device comprising:

- a printed wiring board including a glass substrate(element 2, Figs 1-6C, 20, Figs 7A-8B, 32, Figs 9A-12B) provided with through-holes(elements 3, Figs 1-6C), conductive patterns (elements 6, Figs 1-6C) provided on both surfaces of the glass substrate in such a manner as to be made conductive to each other via the through holes, and a first sealing member(element 8, Figs 1-6C) provided to fill the through-holes;

Jones et al discloses a device comprising

- a glass substrate having a sealed side surface (elements 2, 30, Figs 3-6) facing a portion to be sealed from moisture and an exposed side surface(bottom side surface of elements 2, Figs 3-6); and, the conductive patterns on said sealed side surface being connected to at least one display element(elements 2,40,19 Figs 3-6).

Stevens et al discloses a display device assembly comprising

- bumps provided on a conductive pattern provided on one surface of a printed wiring board; a protective glass board disposed in such a manner as to face to the one surface of the printed wiring board; a display device provided on the surface, facing to the printed wiring board, of the protective glass board in such a manner as to be connected to the bumps(elements 60,12,30 Fig 3)
- a drive component for driving the display device, the drive component being disposed on the exposed surface of the printed wiring board in such a manner as to be connected to the conductive pattern provided on the other surface of the printed wiring board(elements 70,72, Figs 1-3, see column 5, lines 5-25)

Nakazawa et al discloses a display device assembly wherein:

- a second sealing member is provided in such a manner as to surround a display device while being in contact with a printed wiring board and a protective glass board (element 252, fig 12)

Accordingly, it would have been obvious to one of ordinary skill in the art at the time the

invention was made to have included the glass circuit board with a sealed side surface and an exposed side surface and to connect the conductive patterns to a display element as taught by Fushie et al and Jones et al for the purpose of providing a low pinhole density moisture barrier, as well as, to electrically connect the display element to the substrate(see Jones et al column 8, lines 1-65) and also to arrange the display device components as taught by Stevens for the purpose of achieving a denser array of driver components in order to increase pixel pitch in the display device and additionally to add the second sealing member as taught by Nakazawa et al for the purpose vacuum sealing the assembly as a whole.

Regarding claim 16, Fushie et al disclose the instant wherein the glass substrate is a no-alkali glass substrate (Fig 7A)

Regarding claim 17, Fushie et al discloses wherein a conductive film is provided on an inner wall surface of each of the through-holes in such a manner as to connect the conductive patterns provided on both surfaces of the glass substrate to each other, and an inner space, inside the conductive film, of the through-hole is filled with the sealing member (elements 3,8 Figs 1-6C)

Regarding claim 18, Fushie et al discloses wherein the sealing member is an epoxy resin(elements 8, Figs 1-6C)

Regarding claim 19, Fushie et al discloses wherein the surface of the sealing member exposed from each of the through-holes is covered with a metal film (elements 3,8 Figs 1-6C)

Regarding claim 20, Fushie et al discloses a printed wiring board comprising:

a glass substrate(element 2, Figs 1-6C, 20, Figs 7A-8B, 32, Figs 9A-12B) provided with a plurality of through-holes(elements 3, Figs 1-6C); a plurality of conductive patterns (elements 6, Figs 1-6C) provided on both surfaces of said glass substrate in such a manner as to be made conductive to each other via said through-holes; and a sealing member(element 8, Figs 1-6C) provided to fill said through-holes, wherein each of said conductive patterns has a stacked structure of a chromium film and a copper film formed thereon(elements 5a,5b,5c, 35a,35b,35c Figs 1-14).

Response to Arguments

Applicant's arguments filed 10/24/2005 have been fully considered but they are not persuasive. The Office recognizes, that the arguments presented therein amount to a general allegation that the claims define a patentable invention without specifically pointing out how the language of the claims patentably distinguishes them from the references.

In response to applicant's argument at page 1 of the remarks, that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art (Fushie et al, Jones)to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See *In re Fine*, 837 F.2d 1071, 5 USPQ2d 1596 (Fed. Cir. 1988)and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed.

Cir. 1992). In this case, the knowledge generally available to one skilled in the art would suggest that a glass substrate may be used in constructing a display device. It is necessary to employ such a glass substrate in order to mount electronics devices used in the display apparatus thereon.

Additionally, Applicants, at page 2, argue that Jones does not teach a sealed side surface. In response, elements 20 and 30 in Jones et al teach a seal and sealing plate on the surface of the substrate 2.

Applicants further argue that Fushie does not teach a display device. In response, the Office indicates that Fushie is not employed in the rejections as teaching a display device. The display device is taught by Stevens et al which is not addressed in Applicant's arguments and will not be further discussed herein.

Applicants further argue that there is no explanation as to how Fushie is relevant to the claimed invention. In response, the knowledge generally available to one skilled in the art would suggest that a glass substrate may be used in constructing a display device. It is necessary to employ such a glass substrate in order to mount electronics devices used in the display apparatus thereon.

This rejection is maintained by the Office.

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not

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mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

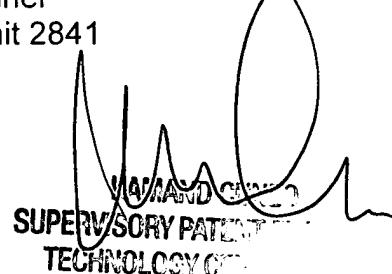
Any inquiry concerning this communication or earlier communications from the examiner should be directed to Dameon E. Levi whose telephone number is (571) 272-2105. The examiner can normally be reached on Mon.-Fri. (9:00 - 5:00).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Kamand Cuneo can be reached on (571) 272-1957. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Dameon E Levi
Examiner
Art Unit 2841

DEL


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